PNP General-Purpose Amplifier

PZTA56, MMBTA56

General Description

This device is designed for general-purpose amplifier applications at collector currents to 300 mA. Sourced from process 73.

Features

• These are Pb-Free Devices

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted) (Note 1, Note 2)

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage	-80	٧
V _{CBO}	Collector-Base Voltage	-80	٧
V _{EBO}	Emitter-Base Voltage	-4.0	٧
I _C	Collector Current – Continuous	-500	mA
T _J , T _{STG}	J, T _{STG} Operating and Storage Junction Temperature Range		ç

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. These ratings are based on a maximum junction temperature of 150°C.
- 2. These are steady-state limits. ON Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.



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SOT-223-4 CASE 318H

FS

Ζ

Х

A56



FSZXYYKK A56

= On Semiconductor Logo

= Assembly Plant Code

= Single Digit Numeric Year Code Last Digit of the Calendar Year

YY = Two Digit Weekly Numeric Code ΚK

= Two Alphanumeric Character Lot Code

= Device Code

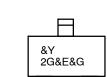


SOT-23-3 CASE 318BM

2G

&E

&G



MARKING DIAGRAM

= ON Semiconductor Logo = Specific Device Code = Designated Space = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]	
PZTA56	SOT-223-4	4000 Tape & Reel	
MMBTA56	SO-23-3	3000 Tape & Reel	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PZTA56, MMBTA56

THERMAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

		Max		
Symbol	Parameter	PZTA56 (Note 3)	MMBTA56 (Note 4)	Unit
P _D	Total Device Dissipation	1000	350	mW
	Derate Above 25°C	8.0	2.8	mW/°C
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient	125	357	°C/W

^{3.} PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Max	Unit
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage (Note 5)	$I_C = -1.0 \text{ mA}, I_B = 0$	-80		V
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -100 \mu\text{A}, I_E = 0$	-60		V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = -100 \mu\text{A}, I_C = 0$	-4.0		V
I _{CES}	Collector Cut-Off Current	V _{CE} = -60 V, I _B = 0		-0.1	μΑ
I _{CBO}	Collector Cut-Off Current	$V_{CB} = -80 \text{ V}, I_{E} = 0$		-0.1	μΑ
h _{FE}	DC Current Gain	$I_C = -10 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100		
		$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100		
V _{CE} (sat)	Collector-Emitter Saturation Voltage	$I_C = -100 \text{ mA}, I_B = -10 \text{ mA}$		-0.25	V
V _{BE} (on)	Base-Emitter On Voltage	$I_C = -100 \text{ mA}, V_{CE} = -1.0 \text{ V}$		-1.2	V
f _T	Current Gain – Bandwidth Product	$I_{C} = -100 \text{ mA}, V_{CE} = -1.0 \text{ V},$ f = 100 MHz	50		MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{4.} Device mounted on FR-4 PCB 36 mm x 18 mm x 1.5 mm; mounting pad for the collector lead minimum 6cm².

^{5.} Pulse test: pulse width \leq 300 $\mu s,$ duty cycle \leq 2.0%.

PZTA56, MMBTA56

TYPICAL PERFORMANCE CHARACTERISTICS

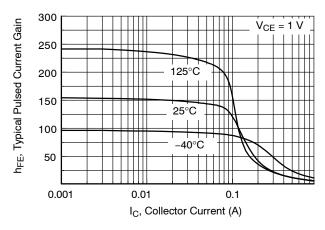


Figure 1. Typical Pulsed Current Gain vs. Collector Current

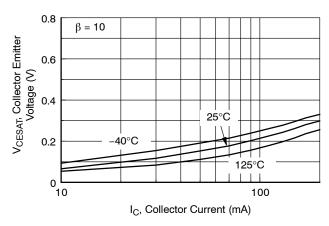


Figure 2. Collector – Emitter Saturation Voltage vs. Collector Current

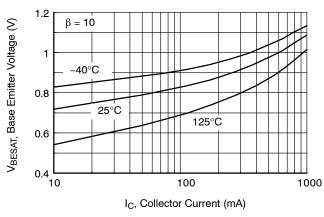


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

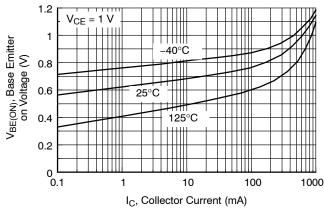


Figure 4. Base-Emitter On Voltage vs. Collector Current

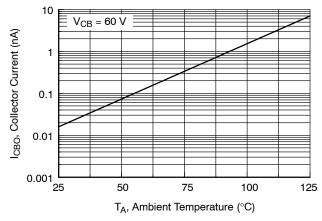


Figure 5. Collector Cut-Off Current vs. Ambient Temperature

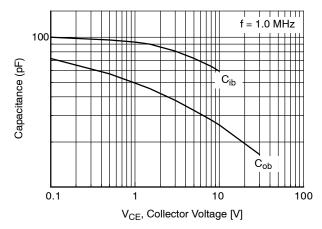


Figure 6. Input and Output Capacitance vs. Reverse Voltage

PZTA56, MMBTA56

TYPICAL CHARACTERISTICS (continued)

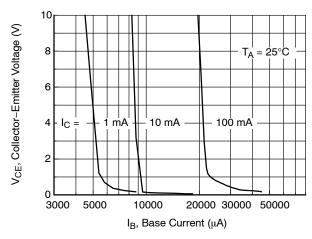


Figure 7. Collector Saturation Region

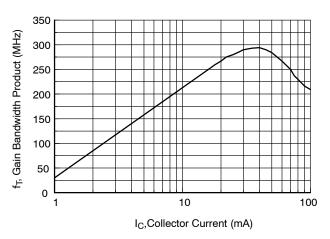


Figure 8. Gain Bandwidth Product vs. Collector Current

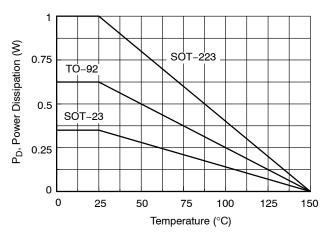


Figure 9. Maximum Safe Operating Area

3



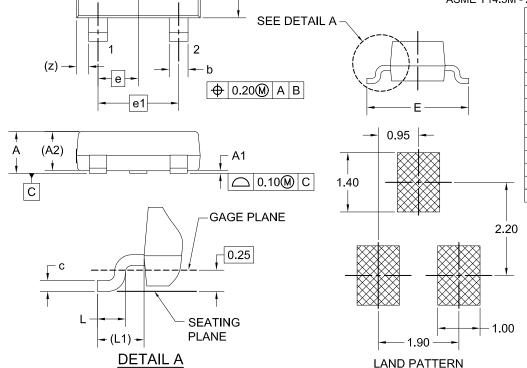


SOT-23 CASE 318BM ISSUE A

DATE 01 SEP 2021



- A) REFERENCE JEDEC REGISTRATION TO-236, VARIATION AB, ISSUE H.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE INCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR EXTRUSIONS.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M 2009.



Α

В

E1

MILLIMETERS NOM. MIN. MAX. Α 1.20 Α1 0.00 0.05 0.10 A2 0.93 REF b 0.37 0 44 0.60 0.08 0.23 С 0.15 D 2.72 2.92 3.12 Ε 2.10 2.40 2.70 E1 1.15 1.30 1.50 0.95 BSC е 1.90 BSC e1 0.20 L ---L1 0.55 REF z 0.29 REF

GENERIC MARKING DIAGRAM*



*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

RECOMMENDATION

XXX = Specific Device Code
M = Date Code

■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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SCALE 2:1

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A

В

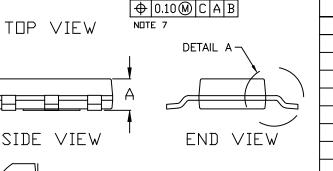
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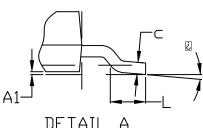
NOTES

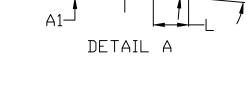
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- DIMENSIDNING AND TOLERANCING PER ASME
 Y14.5M, 2009.
 CONTROLLING DIMENSION: MILLIMETERS
 DIMENSIONS D & E1 ARE DETERMINED AT DATUM
 H. DIMENSIONS DO NOT INCLUDE MOLD FLASH,
 PROTRUSIONS DR GATE BURRS. SHALL NOT
 EXCEED 0.23mm PER SIDE.
 LEAD DIMENSIONS & AND &1 DO NOT INCLUDE
 DAMBAR PROTRUSION. ALLOWABLE DAMBBAR
 PROTRUSION IS 0.08mm PER SIDE.
 DATUMS A AND B ARE DETERMINED AT DATUM H.
 A1 IS DEFINED AS THE VERTICAL DISTANCE
 FROM THE SEATING PLANE TO THE LOWEST
 POINT OF THE PACKAGE BODY.
 POSITIONAL TOLERANCE APPLIES TO DIMENSIONS
 & AND &1.

- b AND b1.

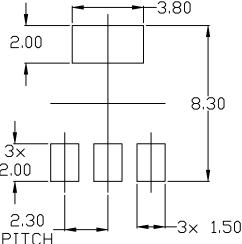
	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α		-	1.80	
A1	0.02	0.06	0.11	
b	0.60	0.74	0.88	
b1	2.90	3.00	3.10	
С	0.24		0.35	
D	6.30	6.50	6.70	
E	6.70	7.00	7.30	
E1	3.30	3.50	3.70	
е	2.30 BSC			
L	0.25			
į.	0*		10°	







3x2.00 2,30



GENERIC MARKING DIAGRAM*

AYW XXXXX. = Assembly Location

= Year **W**

= Work Week XXXXX = Specific Device Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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